# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Akihisa Shimomura	11/12/2008
Masaki KOYAMA	11/12/2008
Satohiro OKAMOTO	11/12/2008

#### **RECEIVING PARTY DATA**

Name:	Semiconductor Energy Laboratory Co., Ltd.
Street Address:	398, Hase
City:	Atsugi-shi, Kanagawa-ken
State/Country:	JAPAN
Postal Code:	243-0036

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12275809

#### **CORRESPONDENCE DATA**

Fax Number: (877)769-7945

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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ATTORNEY DOCKET NUMBER:	12732-0582001
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NAME OF SUBMITTER: Sharon M. Washington

Total Attachments: 1

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PATENT

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## **ASSIGNMENT**

For valuable consideration, We, <u>Akihisa SHIMOMURA of Isehara, Kanagawa, Japan, Masaki KOYAMA of Atsugi, Kanagawa, Japan and Satohiro OKAMOTO of Atsugi, Kanagawa, Japan hereby assign to Semiconductor Energy Laboratory Co., Ltd., a <u>Japanese</u> corporation having a place of business at:</u>

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled METHOD FOR MANUFACTURING SEMICONDUCTOR SUBSTRATE AND SEMICONDUCTOR SUBSTRATE MANUFACTURING APPARATUS, filed November 21, 2008, and assigned U.S. Serial Number 12/275,809 and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature	Akihisa SHIMOMURA
Name:	Akihisa SHIMOMURA
Date:	11/12/208
Signature Name: Date:	Masaki KOYAMA  11/12/2008
Signature	Sutohin Okamata
Name:	Satohiro OKAMOTO
Date	11/12/2008

**RECORDED: 11/24/2008** 

PATENT REEL: 021883 FRAME: 0690